

Project Title:

SMART Reactors Project A04: Self-regulating enhanced surfaces for autonomously operated bioprocesses

Related Publication:

Rennpferdt, Lukas, Sven Bohne, and Hoc Khiem Trieu. "Enhancing the Applicability of Femtosecond Laser Written Waveguides in Fused Silica." *MikroSystemTechnik Kongress 2025; Kongress. VDE, 2025.*

Principal Investigators / Authors:

Rennpferdt, Lukas, Institute of Microsystems Technology, Hamburg University of Technology, Hamburg, Germany
Sven Bohne, Institute of Microsystems Technology, Hamburg University of Technology, Hamburg, Germany
Hoc Khiem Trieu Institute of Microsystems Technology, Hamburg University of Technology, Hamburg, Germany

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1. General Information

Data set Title:

Optical Profilometer Dataset for Diced Surfaces Obtained with Wafer Dicing Machine at Varying Feed Velocities

Short Description:

The dataset contains raw data generated with an optical profilometer of the surface roughness of wafer-level diced fused silica with different feed velocities. The data set can be used to display and analyze the recorded surface roughness of the diced surfaces.

Date of Data Collection:

2025-08-10

Geographical Coverage (if applicable):

Eißendorfer Straße 42, 21073 Hamburg, Germany

Keywords:

Optical Profilometer, Surface Roughness, Quartz Wafer, Waveguide Endfacet

2. Methodological Information

Data Collection and Processing:

The data were measured using a Keyence VK-X3000 optical profilometer in white-light interferometer mode with an 10x objective.

Experimental Design / Study Context:

A fused silica wafer (1 mm thickness, 100 mm diameter) was diced with a wafer dicing machine (Disco DAD3350) at different feed velocities from 0.1 mm/s to 5 mm/s. The spindle speed was set to 30.000 rpm and a diamond blade (Disco, R07-SDC600-BB101-75) was used. The wafer was diced through completely. Then the samples were placed in a sample holder and the diced surface was analyzed with the optical profilometer.

3. Data and File Overview

List of Files and Structure:

File / Folder	Description	Format	Size
data_raw/	Raw data files	.vk7	24.7 MB

File Naming Convention:

File naming: “Dicing_surfaceroughness_white_light_XXmms.vk7”

“XX” displays the related feed velocity. 0_1 → 0.1 mm/s; 1 → 1mm/s

Number of Records / Observations:

The dataset includes six 2D maps of the surface profile, each for a different feed velocity.

4. Access and Licensing Information

Repository and Persistent Identifier:

Published via TORE, DOI: <https://doi.org/10.15480/882.15763>

License for Use:

Public Domain

Text for Citation:

The dataset should be cited using <https://doi.org/10.15480/882.15763>.

5. Reproducibility and Software Dependencies

Software Required:

Keyence VK-X 3000 MultiFileAnalyzer (VK-A3D)

Scripts, Workflow and Reproducibility Notes:

The dataset shows a 2D map from the surface roughness for each diced sidewall. The surface roughness was measured as the line roughness in multiple-line mode.

6. Ethical and Legal Aspects

Data Protection:

-

Consent Statement:

-

7. Versioning and Updates

Version Number:

Version v1.0

Date of Release:

2026-01-28

Change Log:

-

8. Contact Information

Corresponding Author:

Name: Lukas Rennpferdt

Institution: Institute of Microsystems Technology, Hamburg University of Technology,

Hamburg, Germany
Email: lukas.rennpferdt@tuhh.de